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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Christoph A. Wasshuber

Art Unit: 2818

Serial No.: 10/714,366

Examiner: Nguyen, T.

Filing Date: 11/13/2003

Docket No.: TI-36280

Customer No.: 23494

Conf. No.: 1864

Title: FORMING A SEMICONDUCTOR STRUCTURE IN MANUFACTURING A  
SEMICONDUCTOR DEVICE USING ONE OR MORE EPITAXIAL GROWTH  
PROCESSES

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<b>NAME OF INVENTOR(S):</b> Wasshuber		<b>RECEIPT DATE &amp; SERIAL NO.:</b>  <b>Serial No.: 10/714,366</b> <b>Filing Date: 11/13/2003</b> <b>Conf. No.: 1864</b>
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